PACKAGING FOR ARTIFICIAL NAILS

Inventor: Sung Yong Chang, Roslyn Heights, NY (US)

Assignee: KMC Exim Corp., Port Washington, NY (US)

Term: 14 Years

Filed: Mar. 7, 2003

LOC (7) Cl. 09-03
U.S. Cl. D9/418; D9/347; D9/423

References Cited
U.S. PATENT DOCUMENTS
4,196,614 A 8/1978 Aylott
4,140,139 A 2/1979 Aylott
D283,104 S * 3/1986 Bigando D9/418
5,816,408 A 10/1998 Indelicato

D408,279 S 4/1999 Fracassi et al.
5,894,228 A 4/1999 Chang
D441,192 S 5/2001 Park
D443,508 S * 6/2001 Nantel D9/425
D484,542 S * 12/2003 Hsueh D9/425

* cited by examiner

Primary Examiner—Philip S. Hyder
Assistant Examiner—Daniel Bui
Attorney, Agent, or Firm—Hoffmann & Baron, LLP

CLAIM

The ornamental design for packaging for artificial nails, as shown and described.

DESCRIPTION

FIG. 1 is a top front perspective view of a packaging for artificial nails showing my new design;
FIG. 2 is a front elevation view thereof;
FIG. 3 is a left side elevation view thereof;
FIG. 4 is a right side elevation view thereof;
FIG. 5 is a back elevation view thereof;
FIG. 6 is a top plan view thereof;
FIG. 7 is a bottom plan view thereof and,
FIG. 8 is a top perspective view of the packaging shown in FIG. 1 with the cover open.

1 Claim, 6 Drawing Sheets